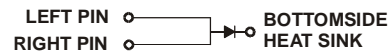
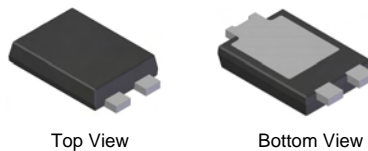


## Features

- Designed as Bypass Diodes for Solar Panels
- Selectively Rated for 200°C Maximum Junction Temperature for High Thermal Reliability
- Patented Super Barrier Rectifier Technology
- Low Forward Voltage Drop
- Excellent High Temperature Stability
- **Lead Free Finish, RoHS Compliant (Note 2)**

## Mechanical Data

- Case: PowerDI<sup>®5</sup>
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 ③
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.093 grams (approximate)



**Note:** Pins Left & Right must be electrically connected at the printed circuit board.

## Maximum Ratings @<sub>T<sub>A</sub></sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	45	V
Working Peak Reverse Voltage	$V_{RWM}$		
DC Blocking Voltage	$V_{RM}$		
Average Rectified Output Current	$I_O$	12	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	$I_{FSM}$	280	A

## Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Case (Note 3)	$R_{\theta JC}$	3	°C/W
Typical Thermal Resistance Junction to Ambient (Note 3)	$R_{\theta JA}$	27	°C/W
Operating Temperature Range	$T_J$	$V_R \leq 80\% V_{RRM}$	-65 to +150
		$V_R \leq 50\% V_{RRM}$	≤180
		DC Forward Mode	≤200
Storage Temperature Range	$T_{STG}$	-65 to +175	°C

## Electrical Characteristics @<sub>T<sub>A</sub></sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	$V_F$	-	-	0.60	V	$I_F = 12A, T_J = 25^\circ C$
		-	0.5	0.56		$I_F = 12A, T_J = 125^\circ C$
Leakage Current (Note 1)	$I_R$	-	0.05	0.3	mA	$V_R = 45V, T_J = 25^\circ C$
		-	17	75		$V_R = 45V, T_J = 125^\circ C$

- Notes:
1. Short duration pulse test used to minimize self-heating effect.
  2. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
  3. Polyimide PCB, 2oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.

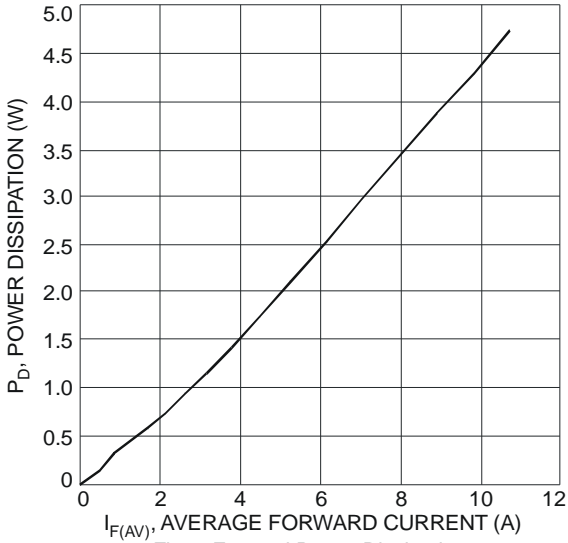


Fig. 1 Forward Power Dissipation

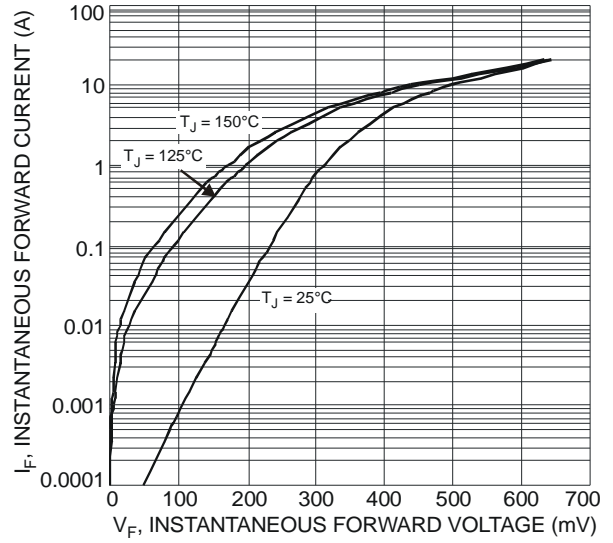


Fig. 2 Typical Forward Characteristics

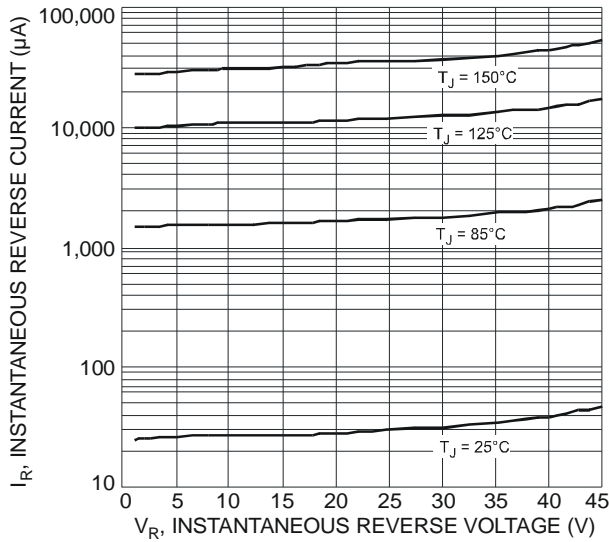


Fig. 3 Typical Reverse Characteristics

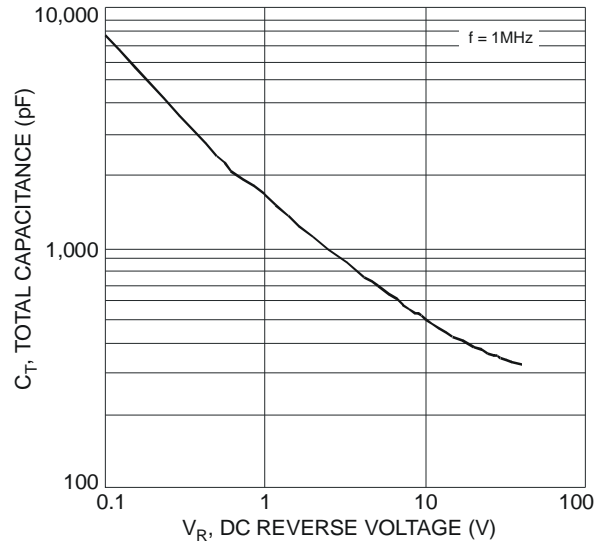


Fig. 4 Total Capacitance vs. Reverse Voltage

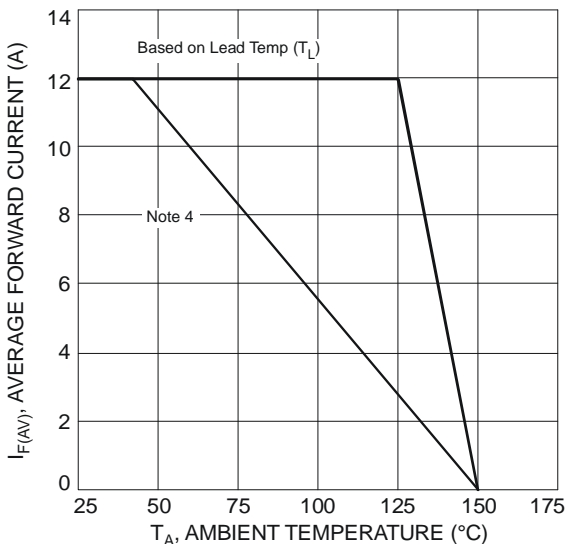


Fig. 5 Forward Current Derating Curve

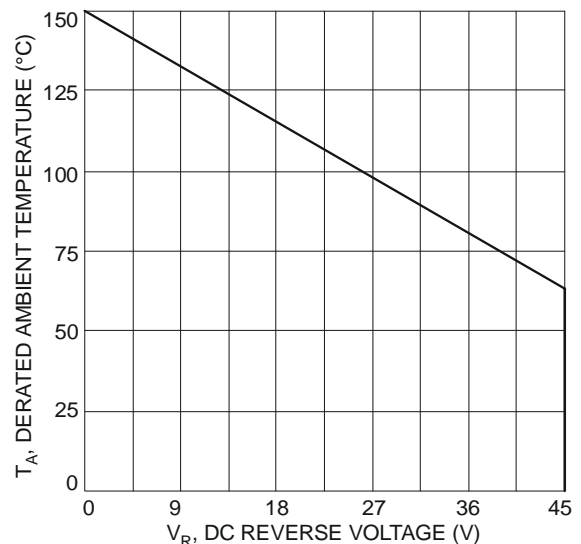
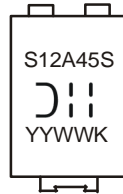


Fig. 6 Operating Temperature Derating

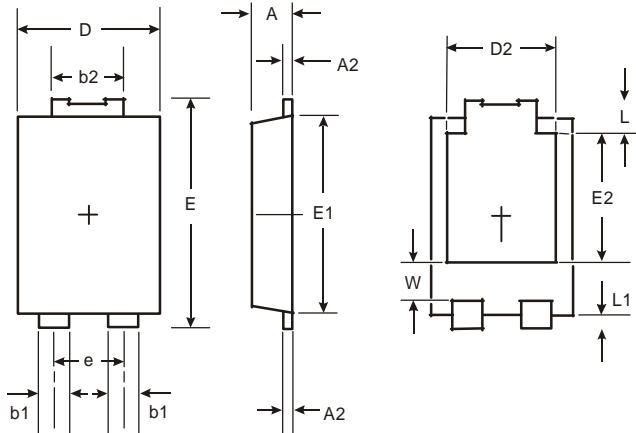
**Ordering Information** (Note 5)

Part Number	Case	Packaging
SBR12A45SP5-13	PowerDI <sup>®</sup> 5	5000/Tape & Reel

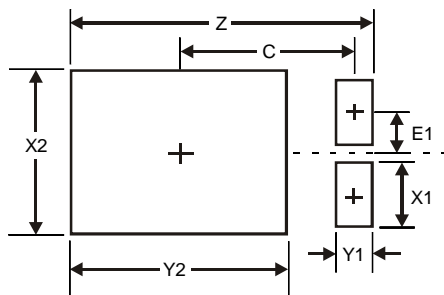
Notes: 5. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

**Marking Information**


S12A45S = Product Type Marking Code  
 ☺ = Manufacturers' code marking  
 K = Factory designator  
 YYWW = Date Code Marking  
 YY = Last two digits of year (ex: 09 for 2009)  
 WW = Week code (01 to 53)

**Package Outline Dimensions**


PowerDI <sup>®</sup> 5		
Dim	Min	Max
A	1.05	1.15
A2	0.33	0.43
b1	0.80	0.99
b2	1.70	1.88
D	3.90	4.05
D2	3.054 Typ	
E	6.40	6.60
e	1.84 Typ	
E1	5.30	5.45
E2	3.549 Typ	
L	0.75	0.95
L1	0.50	0.65
W	1.10	1.41
All Dimensions in mm		

**Suggested Pad Layout**


Dimensions	Value (in mm)
Z	6.6
X1	1.4
X2	3.6
Y1	0.8
Y2	4.7
C	3.87
E1	0.9

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